Behavioral Modeling of a Sigma-Delta Modulator for Sensing Photocurrent in a CMOS Image Sensor

S. Garduza-González1, F. Gómez-Castañeda2, V. H. Ponce-Ponce3, and J. A. Moreno-Cadenas4
1Interdisciplinary Professional Unit on Advanced Engineering and Technology (UPIITA)
2, 3Research and Advanced Studies Center (CINVESTAV), 4CIC, all of the National Polytechnic Institute (IPN)
Mexico City, Mexico
Phone (+5255) 5747-3800 E-mail: 1sgarduza@ipn.mx, 2fgomez@cinvestav.mx, 3vponce@cic.ipn.mx

Abstract—We propose behavioral time-domain modeling for a Sigma-Delta Modulator (ΣΔM) to sense photocurrent in a CMOS Image Sensor (CIS). The model starts from transfer function for first-order single-bit ΣΔM in discrete-time, and then adds noise sources and nonlinearities by introducing noise floor and harmonic distortion, which determine system performance. The results were compared with the measurements of a CIS based ΣΔM circuit prototype fabricated with CMOS technology. The model showed good agreement with measurements.

Keywords—Sigma-Delta modulator, CMOS image sensor, behavioral modeling, passive pixel sensor.

I. INTRODUCTION

Since their invention, the CMOS Image Sensors (CIS) have evolved in reading speed (frames/s), dynamic range, and pixels density, but these issues do not draw any advantage if they are not accompanied by a high-performance ADC, either for immediate visualization of the image or for on- or off-chip post-processing.

The ΣΔM based ADC belongs to the group of oversampling converters, which means that, unlike converters based on Nyquist’s frequency (fNyquist), it can filter temporal noise (noise shaping) without using low pass filters [1], thus requiring a smaller area. Less noise means the Signal-to-Noise Ratio (SNR) is increased, accepting likewise a more dynamic range of the input signal (DRsignal). Nevertheless, a larger DRsignal can lead to nonlinearities in the circuits. The ΣΔM ADC, given its characteristics and settings which are not as accurate (as would be for Nyquist’s converter), supports a range of nonlinearities and thus achieves a specified SNR. These properties make the ΣΔM ADC a suitable choice for the CIS design. According to above, in a CIS, the ADC can be an implemented circuit: pixel, column or chip level. Intermediate performance can be reached by taking the SNR and speed at column level into account.

The SNR is the standard parameter for measuring the ADC performance, but it becomes a problem if there are no analytical expressions developed. Such expressions must contain temporal noise sources that degrade the performance. A good strategy is to consider the main effects that influence the performance and developed their behavioral model. This methodology has been used as a design rule for the design of these systems [2], [3]. This work presents behavioral time-domain modeling for a first-order single-bit ΣΔM embedded in a CIS. The model was developed with Simulink in Matlab and includes real noise sources. The nonlinearity from the light sources is considered, then we add floor noise and harmonic distortion to the model. The results were validated against actual measurements.

II. BACKGROUND

A first-order single-bit ΣΔM discrete-time system consists of an integrator, a quantifier and feedback. If the system meets certain conditions [4], the quantifier is modeled as an additive white noise source with variance $\sigma_q^2$ (in V$^2$/Hz), and its power spectral density (PSD) $N_{eq}(f)$ is:

$$N_{eq}(f) = \frac{\sigma_q^2}{f_s} = \Delta^2/12f_s$$

(1)

Where $\Delta$ is the quantification step and $f_s$ is the sampling frequency. In an ADC, with oversampling rate $R$, the $f_s = R \times f_{Ny}$ and $f_{Ny}$ is the Nyquist’s frequency. Thus, the initial transference function is:

$$Y(z) = z^{-1}X(z) + (1 - z^{-1})E(z)$$

(2)

Where $(z^{-1})$ is the signal transfer function (STF) and $(1 - z^{-1})$ is the noise transfer function (NTF). As the quantification noise $E(z)$ is the only source included in (2), the signal to quantification noise ratio (SQNR) will be the “idealized” reference parameter.

The SQNR is defined as the ratio of the signal power to the quantification noise power [5], i.e. $SQNR = P_{signal}/P_{eq}$. Analytically $P_{eq}$ is calculated by integrating the magnitude of NTF modulated by $N_{eq}(f)$ in the bandwidth (BW) of interest.

$$P_{eq} = \int_{f_h}^{f_l} |NTF|^2N_{eq}(f) df = \frac{\sigma_q^2 \pi^2}{3}$$

(3)

If we take the digitalization of sinusoidal signal, with peak voltage $V_p$, the power is $V_p^2/2$. Then, the obtained SQNR is:

$$SQNR = \frac{18 \cdot R^3 V_p^2}{\pi^2 \Delta^2}$$

(4)

III. CMOS IMAGE SENSOR ARCHITECTURE

The test CMOS Image Sensor is a prototype designed to capture still images in gray scale, and consists of a matrix chip with 24 × 24 passive pixels sensor (PPS), using p-diffusion/n-well photodiode. The $DR_{signal}$ was determined by the physical structure and size of the photodiode, in which we measured from 50 pA to 100 nA, covering a wide range of light intensity. The rows were selected by the shift register and every four
columns share a \( \Sigma \Delta M \) through \( 4 \times 1 \) analog MUX. In addition, there is a test circuit \( \Sigma \Delta M \) making total of \( 9 \) \( \Sigma \Delta M \) similar circuits. The CIS based \( \Sigma \Delta M \) prototype was fabricated with 1.2 \( \mu \)m CMOS technology. A microphotography is shown in Fig. 1. The \( 9 \) \( \Sigma \Delta M \) are enclosed in a rectangle.

The basic cell is formed by a PPS (signal source), a row/column switch and the \( \Sigma \Delta M \), as models (2) and shown in Fig. 2. Conventionally, the integrator is formed by switch-capacitor common-mode feedback [1] since the circuits have a high output swing, high accuracy and low static power consumption, but the circuits occupy a large area of Si. A differential-pair (diff-pair) elemental was chosen and the specification obtained from Spice simulation, are summarized in the Table I. The quantifier is a clocked comparator. A switched-capacitor (SC) circuit works in the feedback as proposed in [6]. The SC circuit carries out the Digital/Analog Converter function. No need a hold capacitor, since the signal to convert (photocurrent) is coming directly from the photodiode.

The test cell is, randomly, selected to estimate the performance. A beam of light from the LED is incident on the photodiode active surface. This beam is modulated by a sinusoidal function with amplitude and frequency like in (6). The test frequency is \( BW = 7.81 \) Hz, \( R = 64 \) and \( f_s = 1 \) kHz. For a modulated power with \( V_p = -3 \) dB (\( V_{ref} = 1 \) V), using (4), is obtained 59.8 dB of SQNR. Model (2) was implemented in Simulink® and simulated 16 input signal cycles. The output signal in time-domain is Pulse Code Modulation (PCM) type and we calculated the PSD with 4096 signal cycles. The output signal in time-domain is Pulse Code Modulation (PCM) type and we calculated the PSD with 4096 signal cycles. The output signal in time-domain is Pulse Code Modulation (PCM) type and we calculated the PSD with 4096 signal cycles. The output signal in time-domain is Pulse Code Modulation (PCM) type and we calculated the PSD with 4096 signal cycles.

Once the “ideal” situation has been modeled, we added no correlated noise sources to the Simulink® model in order to obtain noise floor power (\( P_{NF} \)) and harmonic distortion power (\( P_{HD} \)). We were then able to obtain the Signal-to-Noise and Distortion Ratio (SNDR):

\[
SNDR = \frac{P_{signal}}{P_{eq} + P_{NF} + P_{HD}}
\]

The considered noise sources are modeled in the next section.

IV. BEHAVIORAL MODELING OF NOISE SOURCES

A. Nonlinearity and noise of the light source

The device used to characterize the CIS performance is a LED, whose emitted photon flux density has an incident optical power (\( p_{ph} \), in W/cm\(^2\)) and wavelength spectrum (\( \lambda \), in nm). White light LED was used for our characterization, biased at an operating point, and modulated signal was added. The power \( p_{ph} \) is:

\[
p_{ph}(t) = p_{ph0} + M P_{ph0} \sin \omega_0 t
\]

Where \( \omega_0 \), \( M \) and \( P_{ph0} \) are the deterministic signal angular frequency, the modulation factor and the incident optical power at bias point, respectively. This power is modified by the signal jitter noise and device nonlinearity. In regard to the jitter noise signal, we assume that the excitation signal is displaced by \( \delta t \) in time, changing (6).

\[
p_{phj}(t) = p_{ph}(t + \delta t) - p_{ph}(t)
\]

\[
\approx \omega_0 \delta t P_{ph0} M \cos \omega_0 t = \delta t \frac{d}{dt} p_{ph}(t)
\]

The clock jitter noise added (\( \delta \phi(t) \)) by the SC-circuit phases follows the same model.

Regarding the nonlinearity, we take the device transfer function at the operation point into account. Therefore (8) changes to:

\[
p_{phjnl}(t) = a + c (e^{ap_{phj}} - 1)
\]

Constants \( a, c \) and \( d \) were extracted from the physical properties of the emitter device.
B. Noise source photodiode

The photodiode is the on-chip transducer in which, ideally, each incident photon with associated energy greater than or equal to the Si band gap would create an electron-hole pair (EHP). Throughout this, the EHP forms the photocurrent ($I_{ph}$). We assume that the conversion photon to $I_{ph}$ does not dependent on time. Therefore, the two noise sources to be taken into account are the shot and the thermal ones [2]. The shot noise is caused by the dark current ($I_{dark}$) due to EHP generated in the space charge region and for the photocurrent $I_{ph}$. Each of these currents is generated by independent random processes, and hence all contribute to the shot noise:

$$
\overline{\sigma_{th}^2} = 2q (I_{ph} + I_{dark})
$$

(10)

Thermal noise arises from the parasitic resistances ($R_{in}$) of the photodiode:

$$
\overline{\sigma_{th}^2} = \frac{4kT}{R_{in}}
$$

(11)

Both currents should be evaluated in the bandwidth of interest.

C. Switch-Capacitor (SC) noise source

The switches have finite resistance, which supports internal random carrier fluctuations (thermal energy). Then, when $\phi_1$ closes the switch and the $V_{out}$ is “1”, $C_s$ integrates the signal with these fluctuations and the total noise is [3]:

$$
\overline{\epsilon_{th}^2} = \int_0^\infty \frac{4kT R_{on}}{1 + (\omega_0 R_{on} C_s)} df = \frac{kT}{C_s}
$$

(12)

In fact, the amount of noise accepted due to $\overline{\epsilon_{th}^2}(t)$ is used to calculate the dimensions of $C_s$.

D. Integrator non-idealities

With the exception of the $\overline{\sigma_{th}^2}$ noise, up to now the noise sources arise from optical, technological parameters and from inherent instrument noise. However, by choosing the circuits, we may obtain certain control over the non-idealities of the integrator.

The integrator design involves determining the $b$ coefficient, the open-loop gain ($A_{OL}$), the range of diff-pair output voltage ($V_{out}$), unity gain bandwidth (UGBW) and the slew-rate (SR).

1) Finite DC gain effect: The SC-integrator z-domain transfer function from Fig. 1 is $H(z) = b z^{-1} / (1 - z^{-1})$, where $b = C_s / C_I$. For DC gain, $H(z)$ is infinite. In practice, however, the gain is limited by circuit constraints and by the diff-pair open-loop gain. The finite DC gain effect was modeled by integrator leakage: $\alpha$, measures the output fraction, which is added to the new input sample to be integrated. Then:

$$
H(z) \big|_{DC} = H(1) = b \frac{\alpha}{1 - \alpha} \approx A_{OL}
$$

(13)

The result is that the $H(1)/b$ pole is displaced from the unit circle. This relation is also useful to estimate $A_{OL}$.

Furthermore, the transfer function NTF is modified to:

$$
NTF = \frac{(1 - \alpha z^{-1})}{1 + (1 - \alpha) z^{-1}} E(z)
$$

(14)

If this new NTF is applied to (3) and (4) we may observe the SNR degradation; e.g. we take $A_{OL}$ = 48.8 dB and the simulation yields $SNDR = 58.7$ dB, which is just 1.1 dB less than the reference noise (SQRN). It is recommended that $A_{OL}$ be greater than $R$, ensuring distortion for finite DC gain below 0.3 dB [1].

2) UGBW and SR effects: The integrator output voltage depends on the $A_{OL}$, and is determined by $b$ coefficient and $\alpha$ leakage factor. In the $C_i$ to $C_s$ charge-transfer period $(nT_s - T_s/2)$, the output voltage is $v_0(t) = \alpha V_0 (1 - e^{-t/\tau})$, for $0 < t < T_s/2$.

The slope of this curve is the Slew-Rate, thus, the ideal value is when the maximum slope is reached.

$$
SR_{max} = \frac{d}{dt} v_o(t)|_{t=0} = -\frac{\alpha V_0}{\tau} e^{-t/\tau} \bigg|_{t=0} = \frac{\alpha V_o}{\tau}
$$

(15)

If we consider that only one dominant pole exists, the step response is: $\tau = (1/2\pi) \text{ UGBW}$, and thus the relationship between SR and UGBW: $SR_{max} = \alpha V_o 2\pi \cdot \text{ UGBW}$.

The resulting model is shown in Fig. 3, which implements (8-15). We assumed that the noise is a Gaussian random process with standard deviations (or RMS noise value): $\delta$, $\epsilon_{th}$, $\iota_{th}$ and $\iota_{sh}$ namely due to: jitter noise signal, SC-circuit noise, thermal and shot noise, respectively. Also SC-clock jitter is present with a standard deviation $\delta_{st}$. The UGBW and SR effects are gain integrator variations, as is placed before the integrator.

![Simulink modeling of different noise sources involved in the degradation of SQNR.](image)

![Temporal response of first-order single-bit ΣΔM for sensing photocurrent](image)
noise floor and nonlinear components near of the bandwidth limit. The condition for this estimation and other $\Sigma\Delta M$ specifications are presented in Table III.

VI. Conclusion

It has been shown that a simple behavioral Simulink model predicts the temporal response of a first-order single-bit $\Sigma\Delta M$ quite accurately, and determines the main noise sources that limit performance. On the other hand, the model may be useful for the extraction of electrical specifications of the integrator and the capacitors in the SC-circuits, thus improving circuit design. System level models were presented in [2] and [3] for second-order sigma modulators; however, the basic model presented here is intended to include optical parameters of the sensor (photodiode).

REFERENCES